

# SMD1206P Series

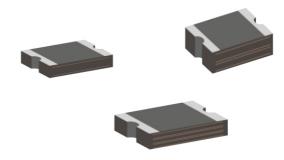
# POSITIVE THERMAL COEFFICIENT(PTC)

#### Description

The 1206 series provides miniature surface mount overcurrent protection with holding current from 0.05A to 2.0A. This series is suitable for wide range of applications in modern electronics where space is limited.

### Features

- I I(hold): 0.05~2.0A
- I Very high voltage surge capabilities
- I Available in lead-free version
- I Fast response to fault current
- I RoHS compliant, Lead- Free and Halogen-Free
- I Low resistance
- I Compact design saves board space
- I Compatible with high temperature solders

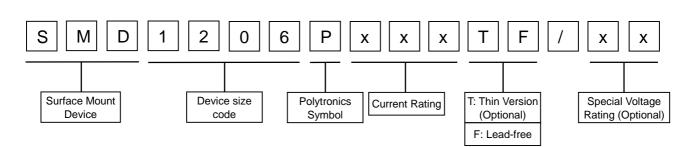


### Applications

- I USB peripherals
- I Disk drives
- I CD-ROMs
- I General electronics
- I Disk drives
- I Set-top-box and HDMI
- I Mobile Internet Device
  - (MID)

- I PDAs / digital cameras
- I Game console port protection
- Plug and play protection for motherboards and peripherals
- Mobile phones battery and port protection

### Part Number Code



#### Environmental Specifications

Test	Test Conditions	Accept/Reject Criteria
Resistance	In still air @ 25°C	$R_{min} \leq R \leq R_{max}$
Time to Trip	Specified current, $V_{max}$ , 25 °C	T≤maximum Time to Trip
Hold Current	30min, at I <sub>H</sub>	No trip
Trip Cycle Life	Vmax, Imax, 100cycles	No arcing or burning
Trip Endurance	Vmax, 1 hours	No arcing or burning



## Physical Characteristics and Environmental Specifications

Terminal materials :	Tin-Plated Nickle-copper				
Soldering zone	Meets EIA specification RS 186-9E and ANSI/J-STD-002 Category 3.				
Environmental Specification	S				
Test	Conditions	Resistance Change			
Passive aging	85°C,1000hours	±10%			
Humidity aging	85°C/85%RH.1000 hours	±5%			
Thermal shock	MIL-STD-202, Method 107G	-30% typical resistance change			
	+85°C/-40°C,20times				
Solvent Resistance	MIL-STD-202,Method 215	no change			
Vibration	ML-STD-883C, Test Condition A	No change			

# Electrical Characteristic

	$V_{\text{Max}}$	I <sub>Max</sub>	I <sub>Hold</sub>	Trip	Maximum Ti	me-to-trip	R	25
Part Number	() ( ) )	(4)	(4)		Current	Time	R <sub>Min</sub>	R1 <sub>Max</sub>
	(Vdc)	(A)	(A)	(A)	(A)	(Sec)	(Ω)	(Ω)
SMD1206P005TF	60.0	100	0.05	0.15	0.25	1.50	3.600	50.000
SMD1206P010TF	60.0	100	0.10	0.25	0.5	1.00	1.600	15.000
SMD1206P010TF/33	33.0	100	0.10	0.25	0.5	1.00	1.600	15.000
SMD1206P012TF	30	100	0.12	0.29	1.00	0.20	1.350	10.00
SMD1206P016TF	30	100	0.16	0.37	1.00	0.30	1.200	4.50
SMD1206P020TF	24.0	100	0.20	0.46	8.0	0.08	0.350	3.500
SMD1206P025TF	16.0	100	0.25	0.50	8.0	0.08	0.350	2.700
SMD1206P030TF	16.0	100	0.30	0.65	8.0	0.10	0.250	2.00
SMD1206P035TF	16.0	100	0.35	0.75	8.0	0.10	0.250	1.300
SMD1206P050TF	6.0	100	0.50	1.00	8.0	0.10	0.150	0.700
SMD1206P050TF/13.2	13.2	100	0.50	1.00	8.0	0.10	0.150	0.700
SMD1206P050TF/16	16	100	0.50	1.00	8.0	0.10	0.150	0.750
SMD1206P050TF/24	24	100	0.50	1.00	8.0	0.10	0.150	0.750
SMD1206P050TF/30	30	100	0.50	1.00	8.0	0.10	0.150	1.00
SMD1206P075TF	6.0	100	0.75	1.50	8.0	0.20	0.090	0.500
SMD1206P075TF/13.2	13.2	100	0.75	1.50	8.0	0.20	0.090	0.500
SMD1206P075TF/16	16	100	0.75	1.50	8.0	0.20	0.090	0.500
SMD1206P100TF	6.0	100	1.00	1.80	8.0	0.30	0.055	0.270
SMD1206P100TF/13.2	13.2	100	1.00	1.80	8.0	0.30	0.055	0.270
SMD1206P100TF/16	16	100	1.00	1.80	8.0	0.30	0.055	0.330
SMD1206P110TF	8.0	100	1.10	1.80	8.0	0.30	0.050	0.230
SMD1206P150TF	6.0	100	1.50	3.00	8.0	1.00	0.040	0.130
SMD1206P200TF	6.0	100	2.00	3.50	8.0	1.0	0.018	0.080

 $V_{max}$  = Maximum operating voltage vice can withstand without damage at rated current (Imax).

 $I_{max}$  = Maximum fault current device can withstand without damage at rated voltage (V max).

P<sub>d</sub> = Power dissipation when device is in the tripped state in 25°C still air environment at rated voltage.

 $R1_{max}$  = Maximum device resistance is measured one hour post reflow.

I hold = Hold Current. Maximum current device will not trip in 25°C still air.

I  $_{\text{trip}}$  = Trip Current. Minimum current at which the device will always trip in 25°C still air.

Ri min/max = Minimum/Maximum device resistance prior to tripping at 25°C.



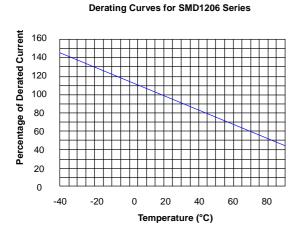
# Thermal Derating Chart-I $_{H}$ ( A )

Part Number –			Maxim	um ambien	t operating	temperatur	es (°C)		
Part Number –	-40	-20	0	25	40	50	60	70	85
SMD1206P005TF	0.09	0.08	0.06	0.05	0.04	0.036	0.033	0.029	0.02
SMD1206P010TF	0.18	0.16	0.12	0.1	0.08	0.072	0.066	0.058	0.04
SMD1206P010TF/33	0.18	0.16	0.12	0.1	0.08	0.072	0.066	0.058	0.04
SMD1206P012TF	0.216	0.192	0.144	0.12	0.096	0.086	0.079	0.070	0.048
SMD1206P016TF	0.288	0.256	0.192	0.160	0.128	0.115	0.106	0.093	0.064
SMD1206P020TF	0.31	0.26	0.22	0.20	0.18	0.16	0.15	0.13	0.07
SMD1206P025TF	0.37	0.33	0.29	0.25	0.22	0.20	0.17	0.15	0.12
SMD1206P030TF	0.444	0.396	0.348	0.30	0.264	0.24	0.204	0.18	0.144
SMD1206P035TF	0.50	0.45	0.40	0.35	0.30	0.27	0.24	0.21	0.15
SMD1206P050TF	0.71	0.64	0.57	0.50	0.42	0.39	0.35	0.31	0.25
SMD1206P050TF/13.2	0.71	0.64	0.57	0.50	0.42	0.39	0.35	0.31	0.25
SMD1206P050TF/16	0.71	0.64	0.57	0.50	0.42	0.39	0.35	0.31	0.25
SMD1206P050TF/24	0.639	0.576	0.513	0.50	0.378	0.351	0.315	0.279	0.22
SMD1206P050TF/30	0.639	0.576	0.513	0.50	0.378	0.351	0.315	0.279	0.22
SMD1206P075TF	1.14	1.01	0.88	0.75	0.65	0.59	0.54	0.49	0.41
SMD1206P100TF	1.45	1.31	1.15	1.00	0.84	0.77	0.69	0.61	0.48
SMD1206P100TF/13.2	1.305	1.179	1.035	1.00	0.756	0.693	0.621	0.549	0.432
SMD1206P100TF/16	1.305	1.179	1.035	1.00	0.756	0.693	0.621	0.549	0.432
SMD1206P110TF	1.595	1.441	1.265	1.10	0.924	0.847	0.759	0.671	0.528
SMD1206P150TF	2.18	1.94	1.72	1.50	1.28	1.17	1.06	0.96	0.77
SMD1206P200TF	2.60	2.44	2.35	2.00	1.78	1.67	1.50	1.45	1.10

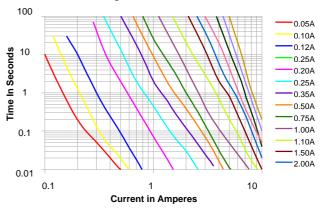


### **Thermal Derating Curve**

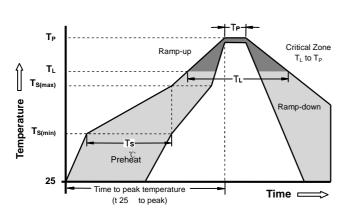
### Average Time-Current Curve



Average Time Current Curves



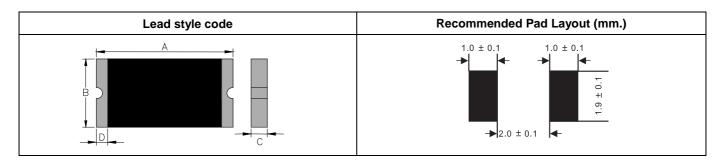
Soldering Parameters



Reflow	Condition	Pb - Free assembly	
	-Temperature Min (T <sub>s(min)</sub> )	150°C	
Pre Heat	-Temperature Max (T <sub>s(max)</sub> )	200°C	
	- Time (min to max) (t <sub>s</sub> )	60 -180 Seconds	
Average T <sub>L</sub> ) to pe	e ramp up rate ( Liquids Temp eak	3°C/second max	
T <sub>S(max)</sub> to	o TL - Ramp-up Rate	3°C/second max	
Reflo	- Temperature (T <sub>L</sub> ) (Liquids)	217°C	
w	- Time (min to max) (t <sub>s</sub> )	60 -150 Seconds	
Peak Te	mperature (T <sub>P</sub> )	260 +0/-5°C	
	thin 5°C of actual peak ature (t <sub>p</sub> )	20 - 40 Seconds	
Ramp-down Rate		6°C/second max	
Time 25	°C to peak Temperature (T <sub>P</sub> )	8 minutes Max	
Do not e	exceed	260°C	



### Recommended pad layout (mm)



# Product Dimensions

# Unit : mm

Part Number	Marking	A B		В	(	2	D E	E	
	iviai kiiig	Max	Min	Max	Min	Max	Min	Min	Min
SMD1206P005TF	JZ	3.00	3.50	1.50	1.80	0.60	1.10	0.15	0.10
SMD1206P010TF	JN	3.00	3.50	1.50	1.80	0.60	1.10	0.15	0.10
SMD1206P010TF/33	JN	3.00	3.50	1.50	1.80	0.50	1.10	0.15	0.10
SMD1206P012TF	JN	3.00	3.50	1.50	1.80	0.60	1.10	0.15	0.10
SMD1206P016TF	JF	3.00	3.50	1.50	1.80	0.40	0.90	0.15	0.10
SMD1206P020TF	JF	3.00	3.50	1.50	1.80	0.40	0.90	0.15	0.10
SMD1206P025TF	JF	3.00	3.50	1.50	1.80	0.40	0.90	0.15	0.10
SMD1206P030TF	JB	3.00	3.50	1.50	1.80	0.40	0.90	0.15	0.10
SMD1206P035TF	JB	3.00	3.50	1.50	1.80	0.40	0.90	0.15	0.10
SMD1206P050TF	JG	3.00	3.50	1.50	1.80	0.35	0.85	0.15	0.10
SMD1206P050TF/13.2	JG	3.00	3.50	1.50	1.80	0.35	0.85	0.15	0.10
SMD1206P050TF/16	JG	3.00	3.50	1.50	1.80	0.35	0.85	0.15	0.10
SMD1206P050TF/24	JG	3.00	3.50	1.50	1.80	0.35	1.20	0.15	0.10
SMD1206P050TF/30	JG	3.00	3.50	1.50	1.80	0.35	1.20	0.15	0.10
SMD1206P075TF	JA	3.00	3.50	1.50	1.80	0.35	0.85	0.15	0.10
SMD1206P075TF/13.2	JA	3.00	3.50	1.50	1.80	0.35	0.85	0.15	0.10
SMD1206P075TF/16	JA	3.00	3.50	1.50	1.80	0.60	1.30	0.15	0.10
SMD1206P100TF	JH	3.00	3.50	1.50	1.80	0.40	0.80	0.15	0.10
SMD1206P100TF/13.2	JH	3.00	3.50	1.50	1.80	0.40	1.30	0.15	0.10
SMD1206P100TF/16	JH	3.00	3.50	1.50	1.80	0.40	1.30	0.15	0.10
SMD1206P110TF	JH	3.00	3.50	1.50	1.80	0.40	0.80	0.15	0.10
SMD1206P150TF	JI	3.00	3.50	1.50	1.80	0.60	1.50	0.15	0.10
SMD1206P200TF	JK	3.00	3.50	1.50	1.80	0.70	1.70	0.15	0.10

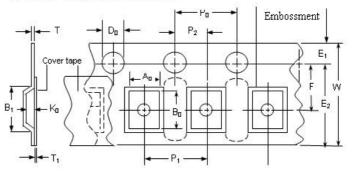


### Taping and Reel Specifications

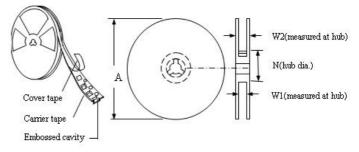
Covering Specifications					
EIA 481-1(Unit:mm)					
W	8.15 +0.15/-0.3				
P <sub>0</sub>	4.0 ± 0.10				
P <sub>1</sub>	4.0± 0.10				
P <sub>2</sub>	$2.0 \pm 0.05$				
A <sub>0</sub>	1.95 ± 0.10				
B <sub>0</sub>	3.65 ± 0.10				
D <sub>0</sub>	1.55± 0.05				
F	$3.50 \pm 0.05$				
E1	1.75 ± 0.10				
Т	0.20± 0.10				
Leader min.	390				
Trailer min.	160				
Reel Dimension	ns				
А	178±1.0				
N	59±1				
W <sub>1</sub>	8.5+1.0/-0.2				
W <sub>2</sub>	12.0±1				

#### EIA Tape Component Dimentions

1



EIA Reel Dimentions



### Packaging Quantity

Quantity		3500		5000		
	SMD1206P005TF	SMD1206P075TF/16	SMD1206P016TF	SMD1206P050TF/13.2		
	SMD1206P010TF	SMD1206P100TF/13.2	SMD1206P020TF	SMD1206P050TF/16		
Part Number	SMD1206P010TF/33	SMD1206P100TF/16	SMD1206P025TF	SMD1206P075TF		
Part Number	SMD1206P012TF	SMD1206P150TF	SMD1206P030TF	SMD1206P075TF/13.2		
	SMD1206P050TF/24	SMD1206P200TF	SMD1206P035TF	SMD1206P100TF		
	SMD1206P050TF/30		SMD1206P050TF	SMD1206P110TF		